APPLICA	BLE STAN	DARD									
	Operating		-55 °C to 105 °C ( <b>n</b>	note 1)	Storage	tempe	erature		-10℃ TO 60℃(Packed c	onditio	on)
RATING	temperature i	range	50V AC/DC		range Operati				•		
RATING	Voltage Current				humidit Applica			KE	Relative humidity 90 % MAX (Not d		
					(FPC/F				(Ground plate : Tin pla		•
			SPEC	SIFICA	1OIT	1S					
ΙΤ	EM		TEST METHOD				RI	EQU	IREMENTS	QT	АТ
CONSTR	UCTION										
General examination		Visually and by measuring instrument.				According to drawing.				×	×
Marking		Confirme	d visually.			(note 2	2)			×	×
ELECTRI	ICAL CHA	RACTE	RISTICS								
Voltage proof		150 V AC for 1 min.				No flashover or breakdown.				×	_
Insulation resistance		100 V DC.				500 MΩ MIN.				×	-
Contact resistance		AC 20 mV MAX , 1 mA .				100 mg	Ω MAX.			×	-
						Including FPC/FFC bulk resistance (L=8mm(FPC) , 20mm(FFC))					
MECHAN	IICAL CHA	RACTE	ERISTICS								
Vibration		Frequency 10 to 55 Hz, half amplitude				① No electrical discontinuity of 1 μs.				×	_
Shock		0.75 mm, for 10 cycles in 3 axial directions.  981 m/s <sup>2</sup> , duration of pulse 6 ms				<ul><li>② Contact resistance: 100 mΩ MAX.</li><li>③ No damage, crack and looseness of parts.</li></ul>				×	l —
Mechanical c	operation	at 3 times in 3 both axial directions.  10 times insertions and extractions.				① Contact resistance: 100 mΩ MAX.				×	-
	oporation.	unies insertions and extractions.				② No damage, crack and looseness of parts.			^		
FPC/FFC insertion/extr	raction force	Measured by applicable FPC/FFC. (Thickness of FPC/FFC shall be t=0.3mm at initial condition.)				Insertion force : Direction of insertion			×	-	
insertion/extr	action force					,	Imber of c		cts) FPC/FFC) ( <i>note 3</i> )		
			condition,					,	(Shielded FFC) ( <i>note 3</i> )		
						Extraction force : Direction of extraction					
						(n : Nu	ımber of c	onta	cts)		
									AX (FPC/FFC) (note 3)		
EDO/EEO						8.5+0.2×n N MAX (Shielded FFC) ( <i>note 3</i> )  Direction of extraction					
FPC/FFC retention force		Measured by applicable FPC/FFC. (Thickness of FPC/FFC shall be t=0.3mm at initial condition.)			(n : Number of contacts)				×	_	
					18+0.05×n N MIN (FPC/FFC) ( <i>note4</i> )						
			,						(Shielded FFC) ( <i>note4</i> )		
ENVIRON	MENTAL	CHARA	ACTERISTICS		L						
Rapid change	e of	Tempera	ture-55→+15⊤0+35→+105-						e: 100 mΩ MAX.	×	_
temperature		Time $30 \rightarrow 2_{to} 3 \rightarrow 30 \rightarrow 2_{to} 3 \text{ min}$				② Insulation resistance: $50 \text{ M}\Omega \text{ MIN}$ .					
Damp heat (	Steady state)	Under 5 cycles.  Exposed at 60±2 °C,			(	③ No damage, crack and looseness of parts.					-
Damp neat (	oleauy State)		at 60±2°C, humidity 90 to 95 %, 96 h.							×	-
Damp heat,cyclic		Exposed at -10 to +65 °c,			(	① Contact resistance: 100 mΩ MAX.				×	1_
		Relative humidity 90 to 96 %,				② Insulation resistance: 1 M $\Omega$ MIN.					
		10 cycles, TOTAL 240 h.				<ul> <li>(At high humidity)</li> <li>③ Insulation resistance: 50 MΩ MIN. (At dry)</li> <li>④ No damage, crack and looseness of parts</li> </ul>					
COUN	T DF	SCRIPTION	ON OF REVISIONS		DESIGN	NFD			CHECKED	DΔ	TE
<b>A</b>	. 51								55,125	٠,ر	
REMARK				1			APPRO\	/ED	YN. TAKASHITA	2019	0912
							CHECK		RT. IKEDA	2019	
							DESIGN		KY. KIKUCHI	2019	
Unless otherwise specified, refer to IEC 6051			fer to IEC 60512		DRAWN		KY. KIKUCHI	20190912			
			חח	DRAWING NO. ELC-388600-00							
SPECIFICATION SHEET				RT NO. FH63S-10S-0. 5SH			<i>.</i>				
			ESTRIC CO. LTD.			01.500			30-4414-0-00		1/2
			ECTRIC CO., LTD. COD		CODE	= NO.   UL58		JUU	U-4414-U-UU		1/2

	SPECIFICAT	IONS		
ITEM	TEST METHOD	REQUIREMENTS	QT	АТ
Dry heat	Exposed at 105±2°C, 96 h.	① Contact resistance: 100 mΩ MAX.	×	_
Cold	Exposed at -55±3°C, 96 h.	② No damage, crack and looseness of parts	×	_
Sulphur dioxide [JIS C 60068-2-42	Exposed at 40±2 °C,  Relative humidity 80±5%  25±5 ppm for 96 h.	① Contact resistance: 100 mΩ MAX.	×	_
Solderability	Soldered at solder temperature, 245±3°C for immersion duration,3±0.3 sec.	A new uniform coating of solder shall cover a minimum of 95 % of the surface being immersed.	×	_
Resistance to soldering heat	1) Reflow soldering: Peak TMP. 250 °C MAX. Reflow TMP. over 220 °C 60 to 90 sec. Number of reflow: 2 times 2) Soldering irons: TMP. 350±10 °C for 5±1 sec.	No deformation of case of excessive looseness of the terminals. (note 5)	×	_

### (note 1)

Follow the specifications of FPC/FFC if it's allowable maximum operating temperature is below 105°C.

### (note 2)

This product features bottom-contact point.

"One Action Lock" completes FPC/FFC lock just by inserting the FPC/FFC.

Do not operate the actuator when inserting the FPC/FFC.

### (note 3)

Do not insert the FPC/FFC to this product at an angle.

## (note 4)

Stabilize the FPC/FFC to PCB or something fixed, if pull-up or pull-down force is exepected to be applied to the FPC/FFC.

There's a case witch FPC/FFC retention force doesn't fulfill the value, because FPC/FFC specification affects the result of FPC/FFC retention force.

# (note 5)

Blisters which may be generated on the housing do not affect product performance.

### (note 6)

The occurrence and the length of whisker, and the performance deterioration caused by it are out of the scope of this specification

Note QT:Qualification Test AT:Assurance Test X:Applicable Test			DRAWIN	NG NO.	ELC-388600-00-00		
HS SI		SPECIFICATION SHEET	PART NO. FH63S-10S-0. 5SH			1	
11.0	HIROSE ELECTRIC CO., LTD.	CODE NO	CL580	)-4414-0-00	Δ	2/2	